



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	BAS 70-02L E6327	<b>Issued</b>	15. May 2021
<b>MA#</b>	MA005311468		
<b>Package</b>	PG-TSLP-2-1	<b>Weight*</b>	0.52 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.001	0.10		1040	
	noble metal	gold	7440-57-5	0.002	0.40		4036	
	inorganic material	silicon	7440-21-3	0.026	4.93	5.43	49273	54349
leadframe	non noble metal	nickel	7440-02-0	0.100	19.31	19.31	193128	193128
wire	noble metal	gold	7440-57-5	0.006	1.12	1.12	11202	11202
encapsulation	inorganic material	antimonytrioxide	1309-64-4	0.000	0.03		349	
	organic material	carbon black	1333-86-4	0.004	0.70		6984	
	plastics	epoxy resin	-	0.049	9.43		94281	
	inorganic material	silicondioxide	60676-86-0	0.310	59.68	69.84	596761	698375
leadfinish	noble metal	gold	7440-57-5	0.010	1.86	1.86	18583	18583
plating	noble metal	palladium	7440-05-3	0.003	0.58		5780	
	noble metal	gold	7440-57-5	0.010	1.86	2.44	18583	24363
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

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